

TENTATIVE

Features and Applications

- Low ON-state resistance.
- Low Qg.

Absolute Maximum Ratings / Ta=25°C

			unit
Drain to Source Voltage	VDSS	500	V
Gate to Source Voltage	VGSS	±30	V
Drain Current(DC)	ID*	10	A
Drain Current(Pulse)	IDP	40	A
Allowable power Dissipation	PD (TC=25°C)	50	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to ±150	°C

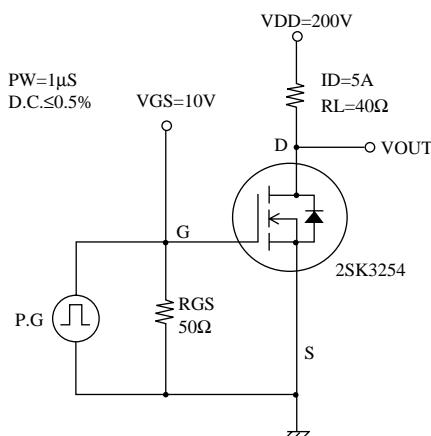
*):Chip Performance Shown

Electrical Characteristics / Ta=25°C

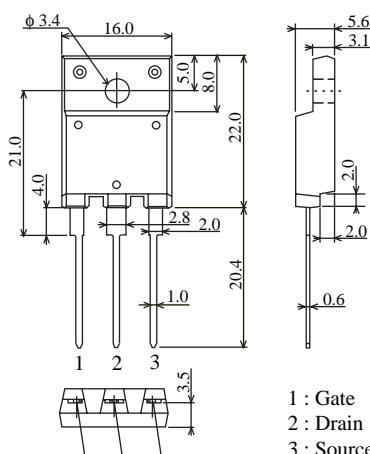
			min	typ	max	unit
Drain to Source Breakdown Voltage	V(BR)DSS	ID=1mA , VGS=0	500			V
Zero Gate Voltage Drain Current	IDSS	VDS=500V , VGS=0			250	µA
Gate to Source Leakage Current	IGSS	VGS=±30V , VDS=0			±100	nA
Cutoff Voltage	VGS(off)	VDS=10V , ID=1mA	2.5		3.5	V
Forward Transfer Admittance	yfs	VDS=10V , ID=5A	2.4	6.3		S
Static Drain to Source	RDS(on)	ID=5A , VGS=10V		0.8	1.0	Ω
On State Resistance						
Input Capacitance	Ciss	VDS=20V , f=1MHz	880			pF
Output Capacitance	Coss	VDS=20V , f=1MHz	140			pF
Reverse Transfer Capacitance	Crss	VDS=20V , f=1MHz	48			pF
Total Gate Charge	Qg	VDS=200V , ID=5A VGS=10V	30			nC
Turn-ON Delay Time	td(on)		17			ns
Rise Time	tr	See Specified Test	35			ns
Turn-OFF Delay Time	td(off)	Circuit	100			ns
Fall Time	tf		38			ns
Diode Forward Voltage	VSD	IS=5A , VGS = 0			1.5	V

(Note) Be careful in handling the 2SK3254 because it has no protection diode between gate and source.

Switching Time Test Circuit



Package Dimensions TO-3PML(unit:mm)



Specifications and information herein are subject to change without notice.

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